

UNITED STATES

DECLARATION FOR PATENT APPLICATION Docket No. NECM 19.067

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled EMI SHIELDING STRUCTURES

the specification of which

(check one) ☒ is attached hereto.
☐ was filed on _____ as
Application Serial No. _____
and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed
2000-313212	Japan	13/10/2000	Yes <input checked="" type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	
			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	
			Yes No
(Number)	(Country)	(Day/Month/Year Filed)	

I hereby claim the benefit under Title 35, United State Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)

I hereby appoint as my attorney Aaron B. Karas, Reg. No. 18,923 and Samson Helfgott, Reg. No. 23,072 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Address all correspondence to: **HELFGOTT & KARAS P.C.**
60th Floor
Empire State Building
New York, New York 10118-0110
Telephone No. (212) 643-5000

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Takanobu KAI

Inventor's signature Takanobu Kai Takanobu Kai Date October 5, 2001

Residence Tokyo, Japan Citizenship Japanese

Post Office Address c/o NEC Corporation, 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of : **Takanobu KAI**
Filed: : **Concurrently herewith**
For: : **EMI SHIELDING STRUCTURES**
Serial No. : **Concurrently herewith**

Assistant Commissioner of Patents
Washington, D.C. 20231

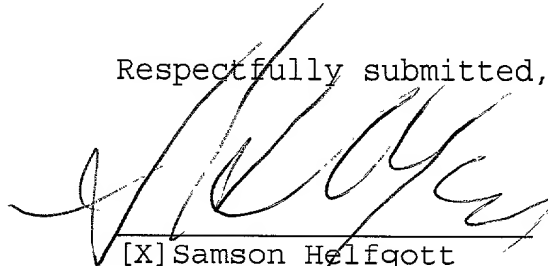
October 12, 2001

SUB-POWER OF ATTORNEY

S I R:

I, Samson Helfgott Reg. No. 23,072 attorney of record herein, do hereby grant a sub-power of attorney to Linda S. Chan, Reg. No. 42,400, Harris A. Wolin, Reg. No. 39,432, Brian S. Myers, Reg. No. 46,947, Michael Markowitz, Reg. No. 30,659, Shahan Islam, Reg. No. 32,507 and Emma Shleifer, Reg. No. 29,734 to act and sign in my behalf in the above-referenced application.

Respectfully submitted,



[X] Samson Helfgott
Reg.No. 23,072

[] Aaron B. Karas
Reg. No. 18,923

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